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Part Number: 0739447216

Status: Active

Overview: HDM Backplane Connector System

**Description:** HDM Board-to-Board Backplane Header, Vertical, SMC, Solder Tail, Guide Pin Option,

Guide Post Location B, Polarizing Key Position N/A, 144 Circuits

**Documents:** 

3D ModelProduct Specification PS-73670-9999-001 (PDF)3D Model (PDF)Packaging Specification PK-70873-0818-001 (PDF)

Drawing (PDF)

RoHS Certificate of Compliance (PDF)

**Agency Certification** 

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series <u>73944</u>
Application Backplane
Component Type PCB Header

Overview HDM Backplane Connector System

Product Name HDM

UPC 800754876551

**Physical** 

Circuits (Loaded) 144
Circuits (maximum) 144

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

Yes

Material - Metal Phosphor Bronze, Stainless Steel

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

Net Weight 8.594/g Number of Columns 24

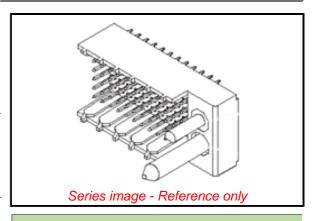
Number of Pairs Open Pin Field

Number of Rows 6
Orientation Vo

Orientation Vertical
PC Tail Length 3.50mm
PCB Locator Yes
PCB Retention None
PCB Thickness - Recommended 2.50mm
Packaging Type Tube
Pitch - Mating Interface 2.00mm
Pitch - Termination Interface 2.00mm

Plating min - Mating 0.762µm
Plating min - Termination 2.540µm
Polarized to PCB No
Stackable No
Surface Mount Compatible (SMC) No

Temperature Range - Operating -55° to +105°C
Termination Interface: Style Through Hole



EU ELV

**Not Relevant** 

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -D(2020)9139-DC (19

Jan 2021)

<u>Halogen-Free</u>

<u>Status</u>

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
ROHS Phthalates Not Contained

**Search Parts in this Series** 

73944 Series

**Mates With** 

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board

Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

**Description** Product # Extraction Tool 621001000

**Electrical** 

Current - Maximum per Contact 1.0A
Data Rate 1.0 Gbps
Shielded No
Voltage - Maximum 250V AC

**Material Info** 

**Reference - Drawing Numbers** 

Packaging Specification PK-70873-0818-001
Product Specification PS-73670-9999-001

Sales Drawing SD-73944-001-001, SD-73944-001-002

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